

## **GENERAL DESCRIPTION**

The LM2596 series of regulators are monolithic integrated circuits that provide all the active functions for a step-down (buck) switching regulator, capable of driving a 3A load with excellent line and load regulation. These devices are available in fixed output voltages of 3.3V, 5V, 12V, and an adjustable output version. Requiring a minimum number of external components, these regulators are simple to use and include internal frequency compensation, and a fixed-frequency oscillator. The LM2596 series operates at a switching

frequency of 150 kHz thus allowing smaller sized filter components than what would be needed with lower frequency switching regulators. Available in a standard 5-lead TO-220 package with several different lead bend options, and a 5-lead TO-263 surface mount package.

A standard series of inductors are available from several different manufacturers optimized for use with the LM2596 series. This feature greatly simplifies the design of switch-mode power supplies.

Other features include a guaranteed  $\pm 4\%$  tolerance on output voltage under specified input voltage and output load conditions, and  $\pm 15\%$  on the oscillator frequency. External shutdown is included, featuring typically 80 µA standby current. Self protection features include a two stage frequency reducing current limit for the output switch and an over temperature shutdown for complete protection under fault conditions.

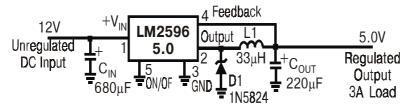
#### FEATURES

- 3.3V, 5V, 12V, and adjustable output versions
  - Adjustable version output voltage range, 1.2V to 37V
- ±4% max over line and load conditions
- Available in TO-220 and TO-263 packages
- Guaranteed 3A output load current
- Input voltage range up to 40V
- Requires only 4 external components
- Excellent line and load regulation specifications
- 150 kHz fixed frequency internal oscillator
- TTL shutdown capability
- Low power standby mode, I<sub>Q</sub> typically 80 μA
- High efficiency
- · Uses readily available standard inductors
- Thermal shutdown and current limit protection

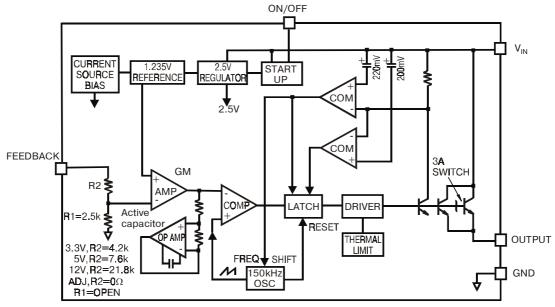
#### **APPLICATIONS**

- Simple high-efficiency step-down (buck) regulator
- On-card switching regulators
- Positive to negative converter

## TYPICAL APPLICATION (Fixed Output Voltage Versions)









#### **PIN FUNCTIONS**

 $+V_{IN}$  - This is the positive input supply for the IC switching regulator. A suitable input bypass capacitor must be present at this pin to minimize voltage transients and to supply the switching currents needed by the regulator.

Ground - Circuit ground.

**Output** - Internal switch. The voltage at this pin switches between ( $+V_{IN} - V_{SAT}$ ) and approximately -0.5V, with a duty cycle of approximately  $V_{OUT} / V_{IN}$ . To minimize coupling to sensitive circuitry, the PC board copper area connected to this pin should be kept to a minimum.

**Feedback** —Senses the regulated output voltage to complete the feedback loop.

**ON/OFF** - Allows the switching regulator circuit to be shut down using logic level signals thus dropping the total input supply current to approximately 80 UA. Pulling this pin below a threshold voltage of approximately 1.3V turns the regulator on, and pulling this pin above 1.3V (up to a maximum of 25V) shuts the regulator down. If this shutdown feature is not needed, the ON /OFF pin can be wired to the ground pin or it can be left open, in either case the regulator will be in the ON condition.

## LM2596-3.3 ELECTRICAL CHARACTERISTICS

ABSOLUTE MAXIMUM RATINGS (Note 1)

Maximum Supply Voltage	45V
ON /OFF Pin Input Voltage	$\textbf{-0.3} \leq V \leq +25V$
Feedback Pin Voltage	$\textbf{-0.3} \leq V \leq +25V$
Output Voltage to Ground	
(Steady State)	-1V
Power Dissipation	Internally limited
Storage Temperature Range	-65 <sup>0</sup> C to +150 <sup>0</sup> C
ESD Susceptibility	
Human Body Model (Note 2)	2 kV
Lead Temperature	
S Package	
Vapor Phase (60 sec.)	+215 <sup>0</sup> C
Infrared (10 sec.)	+245 <sup>0</sup> C
T Package (Soldering, 10 sec.)	+260 <sup>0</sup> C
Maximum Junction Temperature	e +150 <sup>0</sup> C

## **OPERATING CONDITIONS**

Temperature Range	-40 <sup>0</sup> C≤T <sub>J</sub> ≤+125 <sup>0</sup> C
Supply Voltage	4.5V to 40V

Specifications with standard type face are for  $T_J = 25^{\circ}C$ , and those with **boldface type** apply over **full Operating Temperature Range** 

			LM2	596-3.3	Units
Symbol	Parameter	Conditions	<b>Typ</b> (Note 3)	Limit (Note 4)	(Limits)
SYSTEM F	PARAMETERS (Note 5	5)Test Circuit Figure 1			
V <sub>OUT</sub>	Output Voltage	4.7V5≤V <sub>IN</sub> ≤40V, 0.2A≤I <sub>I OAD</sub> ≤3A	3.3		V
				3.168/ <b>3.135</b>	V(min)
				3.432/ <b>3.465</b>	V(max)
η	Efficiency	V <sub>IN</sub> =12V, I <sub>LOAD</sub> =3A	73		%

## LM2596-5.0

## **ELECTRICAL CHARACTERISTICS**

Specifications with standard type face are for  $T_J = 25^0$ C, and those with **boldface type** apply over **full Operating Temperature Range** 

			LM2	596-5.0	Units
Symbol	Parameter	Conditions	Тур	Limit	(Limits)
			(Note 3)	(Note 4)	
SYSTEM F	PARAMETERS (Note 5	5)Test Circuit Figure 1			
V <sub>OUT</sub>	Output Voltage	7V≤V <sub>IN</sub> ≤40V, 0.2A≤I <sub>I OAD</sub> ≤3A	5.0		V
				4.800/ <b>4.750</b>	V(min)
				5.200/ <b>5.250</b>	V(max)
η	Efficiency	V <sub>IN</sub> =12V, I <sub>LOAD</sub> =3A	80		%

## LM2596-12

## **ELECTRICAL CHARACTERISTICS**

Specifications with standard type face are for  $T_J = 25^{0}$ C, and those with **boldface type** apply over **full Operating Temperature Range** 

			LM2	Units			
Symbol	Parameter	Conditions	<b>Typ</b> (Note 3)	Limit (Note 4)	(Limits)		
SYSTEM F	SYSTEM PARAMETERS (Note 5)Test Circuit Figure 1						
V <sub>OUT</sub>	Output Voltage	15V≤V <sub>IN</sub> ≤40V, 0.2A≤I <sub>LOAD</sub> ≤3A	12.0		V		
				11.52/ <b>11.40</b>	V(min)		
				12.48/ <b>12.60</b>	V(max)		
η	Efficiency	V <sub>IN</sub> =12V, I <sub>LOAD</sub> =3A	90		%		



## LM2596-ADJ

## **ELECTRICAL CHARACTERISTICS**

Specifications with standard type face are for  $T_J = 25^{0}$ C, and those with **boldface type** apply over **full Operating Temperature Range** 

			LM2596-ADJ		Units
Symbol	Parameter	Conditions	<b>Typ</b> (Note 3)	Limit (Note 4)	(Limits)
SYSTEM F	PARAMETERS (Note 5	5)Test Circuit Figure 1			
V <sub>OUT</sub>	Output Voltage	4.5V≤V <sub>IN</sub> ≤40V, 0.2A≤I <sub>LOAD</sub> ≤3A	1.230		V
		V <sub>OUT</sub> programmed for 3V. Circuit of		1.193/ <b>1.180</b>	V(min)
		Figure 1.		1.267/ <b>1.280</b>	V(max)
η	Efficiency	$V_{IN}$ =12V, $V_{OUT}$ =3V, $I_{LOAD}$ =3A	73		%

## ALL OUTPUT VOLTAGE VERSIONS ELECTRICAL CHARACTERISTICS

Specifications with standard type face are for  $T_J = 25^{0}$ C, and those with **boldface type** apply over **full Operating Temperature Rang**e. Unless otherwise specified,  $V_{IN} = 12$ V for the 3.3V, 5V, and Adjustable version and  $V_{IN} = 24$ V for the 12V version.  $I_{I,OAD} = 500$  mA

Symbol Parameter			LM2596-XX		Units
		Conditions	Тур	Limit	(Limits)
	_		(Note 3)	(Note 4)	(Ellints)
DEVICE F	PARAMETERS			-	
۱ <sub>b</sub>	Feedback Bias	Adjustable Version Only, V <sub>FB</sub> =1.3V	10		nA
	Current		150	50/ <b>100</b>	nA (max)
f <sub>O</sub>	Oscillator Frequency	(Note 6)	150		kHz
				127/110	kHz (min)
N N		1 = -2A (Nata - 7, 0)	1.10	173/ <b>173</b>	kHz (max)
V <sub>SAT</sub>	Saturation Voltage	I <sub>OUT</sub> =3A (Notes 7, 8)	1.16	1 4 / <b>1</b> E	V
	Max Duty Ovala (ON)	(Note 9)	100	1.4/ <b>1.5</b>	V (max) %
DC	Max Duty Cycle (ON) Min Duty Cycle (OFF)	(Note 8) (Note 9)	100 0		%
1	Current Limit	Peak Current (Notes 7, 8)	4.5		Α
I <sub>CL</sub>		reak Current (Notes 7, 0)	4.5	3.6/ <b>3.4</b>	A (min)
				6.9/ <b>7.5</b>	A (max)
١L	Output Leakage	Output=0V (Notes 7, 9)		50	μA (max)
·L	Current	Output=-1V (Note 10)	2	00	mA
			2	30	mA (max)
Ι <sub>Q</sub>	Quiescent Current	(Note 9)	5		mA
.0		(	•	10	mA (max)
I <sub>STBY</sub>	Standby Quiescent	ON/OFF pin=5V (OFF) (Note 10)	80		μA
0101	Current	, , , , , , ,		200/ <b>250</b>	μA (max)
θ <sub>JC</sub>	Thermal Resistance	TO-220 or TO-263 Package, Junction to Case	2		<sup>0</sup> C/W
θ <sub>JA</sub>		TO-220 Package, Junction to Ambient (Note 11)	50		°C∕W
θ <sub>JA</sub>		TO-263 Package, Junction to Ambient (Note 12)	50		<sup>0</sup> C/W
θ <sub>JA</sub>		TO-263 Package, Junction to Ambient (Note 13)	30		<sup>0</sup> C/W
θ <sub>JA</sub>		TO-263 Package, Junction to Ambient (Note 14)	20		<sup>0</sup> C/W
ON/OFF	CONTROL Test Circuit				-,
,	ON/OFF Pin Logic Input		1.3		V
VIH	Threshold Voltage	Low (Regulator ON)		0.6	V (max)
V <sub>IL</sub>	- ···J-	High (Regulator OFF)		2.0	V (min)
I <sub>H</sub>	ON/OFF Pin Input	V <sub>LOGIC</sub> =2.5V (Regulator OFF)	5		μA
	Current			15	μA (max)
١L	1	V <sub>LOGIC</sub> =0.5V (Regulator ON)	0.02		μΑ
L				5	$\mu A (max)$
					mr (max)

**Note 1:** Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the Electrical Characteristics.

**Note 2:** The human body model is a 100 pF capacitor discharged through a 1.5k resistor into each pin. **Note 3:** Typical numbers are at 25<sup>0</sup>C and represent the most likely norm.

**Note 4:** All limits guaranteed at room temperature (standard type face) and at temperature extremes (bold type face). All room temperature limits are 100% production tested. All limits at temperature extremes are guaranteed via correlation using standard Statistical Quality Control (SQC) methods. All limits are used to calculate Average Outgoing Quality Level (AOQL).

**Note 5:** External components such as the catch diode, inductor, input and output capacitors, and voltage programming resistors can affect switching regulator system performance. When the LM2596 is used as



shown in the Figure 1 test circuit, system performance will be as shown in system parameters section of Electrical Characteristics.

**Note 6:** The switching frequency is reduced when the second stage current limit is activated. The amount of reduction is determined by the severity of current over-load.

Note 7: No diode, inductor or capacitor connected to output pin.

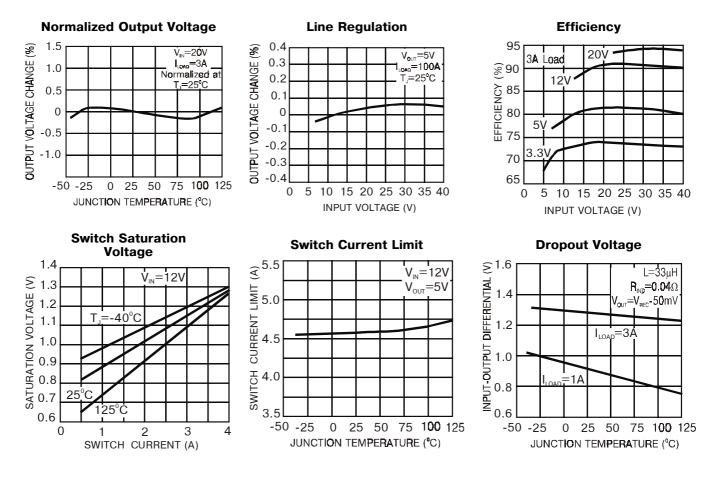
**Note 8:** Feedback pin removed from output and connected to 0V to force the output transistor switch ON. **Note 9:** Feedback pin removed from output and connected to 12V for the 3.3V, 5V, and the ADJ. version, and 15V for the 12V version, to force the output transistor switch OFF. **Note 10:**  $V_{IN} = 40V$ .

**Note 11:** Junction to ambient thermal resistance (no external heat sink) for the TO-220 package mounted vertically, with the leads soldered to a printed circuit board with (1 oz.) copper area of approximately 1 in<sup>2</sup> **Note 12:** Junction to ambient thermal resistance with the TO-263 package tab soldered to a single printed circuit board with 0.5 in<sup>2</sup> of (1 oz.) copper area.

**Note 13:** Junction to ambient thermal resistance with the TO-263 package tab soldered to a single sided printed circuit board with 2.5 in<sup>2</sup> of (1 oz.) copper area.

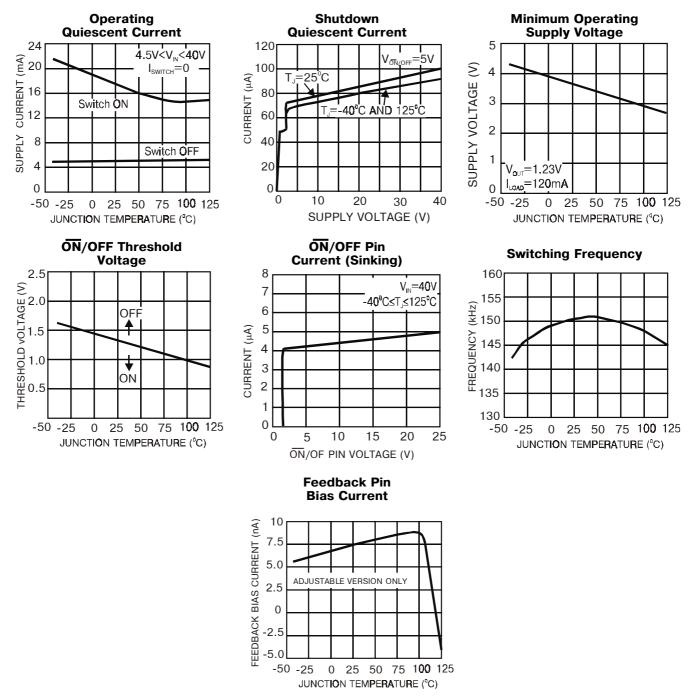
**Note 14:** Junction to ambient thermal resistance with the TO-263 package tab soldered to a double sided printed circuit board with 3 in<sup>2</sup> of (1 oz.) copper area on the LM2596S side of the board, and approximately 16 in<sup>2</sup> of copper on the other side of the p-c board.

## TYPICAL PERFORMANCE CHARACTERISTICS (Circuit of Figure 1)



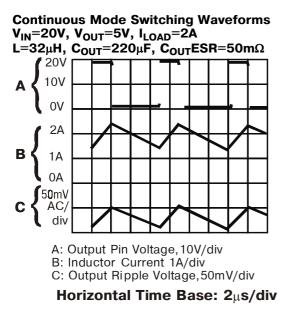


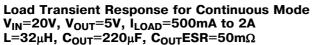
## TYPICAL PERFORMANCE CHARACTERISTICS (Circuit of Figure 1) (Continued)

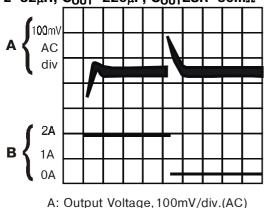




## **TYPICAL PERFORMANCE CHARACTERISTICS**



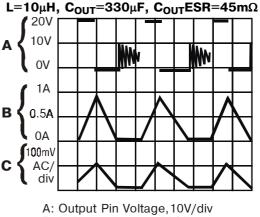




B: 500mA to 2A Load Pulse

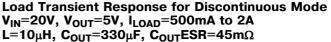
Horizontal Time Base: 100µs/div

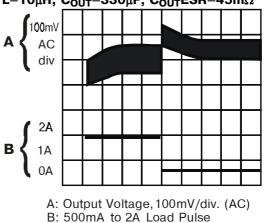
Discontinuous Mode Switching Waveforms  $V_{IN}$ =20V,  $V_{OUT}$ =5V,  $I_{LOAD}$ =500mA



B: Inductor Current 1A/div C: Output Ripple Voltage, 100mV/div

Horizontal Time Base: 2µs/div

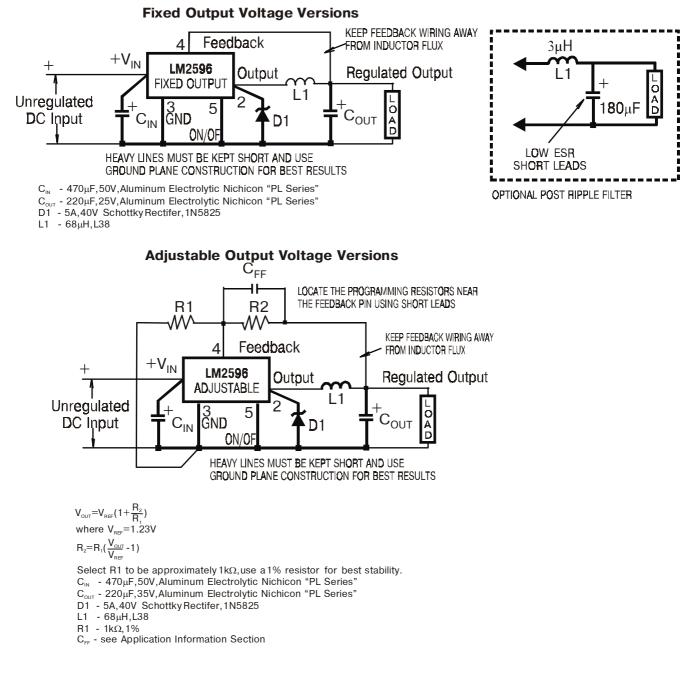




Horizontal Time Base: 200µs/div



## **TEST CIRCUIT AND LAYOUT GUIDELINES**



#### Figure 1. Standard Test Circuits and Layout Guides

As in any switching regulator, layout is very important. Rapidly switching currents associated with wiring inductance can generate voltage transients which can cause problems. For minimal inductance and ground loops, the wires indicated by **heavy lines should be wide printed circuit traces and should be kept as short as possible.** For best results, external components should be located as close to the switcher IC as possible using ground plane construction or single point grounding. If **open core inductors are used**, special care must be taken as to the location and positioning of this

If **open core inductors are used**, special care must be taken as to the location and positioning of this type of inductor. Allowing the inductor flux to intersect sensitive feedback, IC groundpath and  $C_{OUT}$  wiring can cause problems.

When using the adjustable version, special care must be taken as to the location of the feedback resistors and the associated wiring. Physically locate both resistors near the IC, and route the wiring away from the inductor, especially an open core type of inductor.



## LM2596 SERIES BUCK REGULATOR DESIGN PROCEDURE (FIXED OUTPUT)

EM2390 SERIES BUCK REGULATOR DE	· /
PROCEDURE (Fixed Output Voltage Version) Given:	EXAMPLE (Fixed Output Voltage Version) Given:
$V_{OUT}$ = Regulated Output Voltage (3.3V, 5V or 12V) $V_{IN}$ (max) = Maximum DC Input Voltage $I_{LOAD}$ (max) = Maximum Load Current	$V_{OUT} = 5V$ $V_{IN} (max) = 12V$ $I_{LOAD} (max) = 3A$
<b>1. Inductor Selection (L1)</b> <b>A.</b> Select the correct inductor value selection guide from Figures Figure 4, Figure 5,or Figure 6. (Output voltages of 3.3V, 5V, or 12V respectively.) For all other voltages, see the design procedure for the adjustable version.	<ol> <li>Inductor Selection (L1)</li> <li>A. Use the inductor selection guide for the 5V version shown in Figure 5.</li> </ol>
<b>B.</b> From the inductor value selection guide, identify the inductance region intersected by the Maximum Input	<b>B.</b> From the inductor value selection guide shown in Figure 5, the inductance region intersected by the 12V horizontal line and the 3A vertical line is 33 UH, and the inductor code is L40.
<b>C.</b> Select an appropriate inductor from the four manufacturer's part numbers listed in Figure 8.	<b>C.</b> The inductance value required is 33 UH. From the table in Figure 8, go to the L40 line and choose an inductor part number from any of the four manufacturers shown. (In most in-stance, both through hole and surface mount inductors are available.)
<b>2. Output Capacitor Selection (C<sub>OUT</sub>)</b> <b>A.</b> In the majority of applications, low ESR (Equivalent Series Resistance) electrolytic capacitors between 82 UF and 820 UF and low ESR solid tantalum capacitors between 10 UF and 470 UF provide the best results. This capacitor should be located close to the IC using short capacitor leads and short copper traces. Do not	2. Output Capacitor Selection (C <sub>OUT</sub> ) A. See section on output capacitors in application information section.
use capacitors larger than 820 UF. <b>B.</b> To simplify the capacitor selection procedure, refer to the quick design component selection table shown in Figure 2. This table contains different input voltages, output voltages, and load currents, and lists various inductors and output capacitors that will provide the best design solutions.	<b>B.</b> From the quick design component selection table shown in Figure 2, locate the 5V output voltage section. In the load current column, choose the load current line that is closest to the current needed in your application, for this example, use the 3A line. In the maximum input voltage column, select the line that covers the input voltage needed in your application, in this example, use the 15V line. Continuing on this line are recommended inductors and capacitors that will provide the best overall performance. The capacitor list contains both through hole electrolytic and surface mount tantalum capacitors from four different capacitor manufacturers. It is recommended that both the manufacturers and the manufacturers are available with the range of ESR numbers needed. 330 UF 35V Panasonic HFQ Series
<b>C.</b> The capacitor voltage rating for electrolytic capacitors should be at least 1.5 times greater than the output voltage, and often much higher voltage ratings are needed to satisfy the low ESR requirements for low output ripple voltage.	330 UF 35V Nichicon PL Series <b>C.</b> For a 5V output, a capacitor voltage rating at least 7.5V or more is needed. " ut even a low ESR, switching grade, 220UF 10V aluminum electrolytic capacitor would exhibit approximately 225 mW of ESR (see the curve in Figure 14 for the ESR vs voltage rating). This amount of ESR would result in relatively high output ripple voltage. To reduce the ripple to 1% of the output voltage, or less, a capacitor with a higher value or with a higher voltage rating (lower ESR) should be selected. A 16V or 25V capacitor will reduce the ripple volt-age by approximately half.
<b>3. Catch Diode Selection (D1)</b> <b>A.</b> The catch diode current rating must be at least 1.3 times greater than the maximum load current. Also, if the power supply design must withstand a continuous output short, the diode should have a current rating equal to the maximum current limit of the LM2596. The most stressful condition for this diode is an overload or shorted output condition.	<b>3. Catch Diode Selection (D1)</b> <b>A.</b> Refer to the table shown in Figure 11. In this example, a 5A, 20V, 1N5823 Schottky diode will provide the best performance, and will not be overstressed even for a shorted output.
<ul> <li><b>B.</b> The reverse voltage rating of the diode should be at least 1.25 times the maximum input voltage.</li> <li><b>C.</b> This diode must be fast (short reverse recovery time)</li> </ul>	8



PROCEDURE (Fixed Output Voltage Version)	EXAMPLE (Fixed Output Voltage Version)
and must be located close to the LM2596 using short	
leads and short printed circuit traces. " ecause of their fast	
switching speed and low forward voltage drop, Schottky	
diodes provide the best performance and efficiency, and	
should be the first choice, especially in low output voltage applications.	
Ultra-fast recovery, or High-Efficiency rectifiers also	
provide good results. Ultra-fast recovery diodes typically	
have reverse recovery times of 50 ns or less. Rectifiers	
such as the 1N5400 series are much too slow and should	
not be used.	
4. Input Capacitor (C <sub>IN</sub> )	4. Input Capacitor (C <sub>IN</sub> )
A low ESR aluminum or tantalum bypass capacitor is	The important parameters for the Input capacitor are the input
needed between the input pin and ground pin to prevent large volt-age transients from appearing at the input. This	voltage rating and the RMS current rating. With a nominal input voltage of 12V, an aluminum electrolytic capacitor with a
capacitor should be located close to the IC using short	voltage rating greater than 18V (1.5 x $V_{IN}$ ) would be needed. The
leads. In addition, the RMS current rating of the input	next higher capacitor voltage rating is 25V.
capacitor should be selected to be at least 1/2 the DC	The RMS current rating requirement for the input capacitor in
	a buck regulator is approximately 1 /2 the DC load current. In this
be checked to assure that this current rating is not	example, with a 3A load, a capacitor with a RMS current rating of
	at least 1.5A is needed. The curves shown in Figure 9 can be
current ratings for several different aluminum electrolytic	used to select an appropriate input capacitor.
capacitor values.	From the curves, locate the 35V line and note which capacitor
For an aluminum electrolytic, the capacitor voltage rating	values have RMS current ratings greater than 1.5A. A 680UF/35V
should be approximately 1.5 times the maximum input	capacitor could be used.
voltage.	For a through hole design, a 680UF/35V electrolytic capacitor
The tantalum capacitor voltage rating should be 2 times	(Panasonic HFQ series or Nichicon PL series or equivalent) would
the maximum input voltage and it is recommended that	be adequate. other types or other manufacturers capacitors can
they be surge current tested by the manufacturer.	be used provided the RMS ripple current ratings are adequate.
Use caution when using ceramic capacitors for input	For surface mount designs, solid tantalum capacitors can be
bypassing, because it may cause severe ringing at the $V_{\text{IN}}$	used, but caution must be exercised with regard to the capacitor
pin.	surge current rating. The TPS series available from AVX, and the
	593D series from Sprague are both surge current tested.

## LM2596 SERIES BUCK REGULATOR DESIGN PROCEDURE (FIXED OUTPUT) (Continued)

Conditions		Indua	tor	Output Capacitor			•	
Conditions		Induc	lor	Through Ho	le Electrolytic	Surface	Mount Tantalum	
Output Voltage (V)	Load Current (A)	Max Input Voltage (V)	Inductance (µH)	Inductor (#)	Panasonic HFQ Series (μF/V)	Nichicon PL Series (µF/V)	AVX TPS Series (μF/V)	Sprague 595D Series (µF/V)
3.3	3	5	22	L41	470/25	560/16	330/6.3	390/6.3
		7	22	L41	560/35	560/35	330/6.3	390/6.3
		10	22	L41	680/35	680/35	330/6.3	390/6.3
		40	33	L40	560/35	470/35	330/6.3	390/6.3
	2	6	22	L33	470/25	470/35	330/6.3	390/6.3
		10	33	L32	330/35	330/35	330/6.3	390/6.3
		40	47	L39	330/35	270/50	220/10	330/10
5	3	8	22	L41	470/25	560/16	220/10	330/10
		10	22	L41	560/25	560/25	220/10	330/10
		15	33	L40	330/35	330/35	220/10	330/10
		40	47	L39	330/35	270/35	220/10	330/10
	2	9	22	L33	470/25	560/16	220/10	330/10
		20	68	L38	180/35	180/35	100/10	270/10
		40	68	L38	180/35	180/35	100/10	270/10
12	3	15	22	L41	470/25	470/25	100/16	180/16
		18	33	L40	330/25	330/25	100/16	180/16
		30	68	L44	180/25	180/25	100/16	120/20
		40	68	L44	180/35	180/35	100/16	120/20
	2	15	33	L32	330/25	330/25	100/16	180/16
		20	68	L38	180/25	180/25	100/16	120/20
		40	150	L42	82/25	82/25	68/20	68/25

## Figure 2. LM2596 Fixed Voltage Quick Design Component Selection Table **S BUCK REGULATOR DESIGN PROCEDURE (ADJUSTABLE OUTPUT)**

LM2596 SERIES BUCK REGULATOR DESIGN PROCEDURE (ADJUSTABLE OUTPUT)						
PROCEDURE (Adjustable Output Voltage Version)	EXAMPLE (Adjustable Output Voltage Version)					
Given:	Given:					
V <sub>OUT</sub> = Regulated Output Voltage	$V_{OUT} = 20V$					

 $|V_{IN}(max)| = Maximum Input Voltage$ 

 $V_{OUT} = 20V$  $V_{IN}(max) = 28V$ 



PROCEDURE (Adjustable Output Voltage Version)	EXAMPLE (Adjustable Output Voltage Version)
$I_{LOAD}(max) = Maximum Load Current$ F=Switching Frequency (Fixed at a nominal 150 kHz). <b>1. Programming Output Voltage</b> (Selecting R <sub>1</sub> and R <sub>2</sub> , as shown in Figure 1)	$I_{LOAD}(max) = 3A$ F=Switching Frequency (Fixed at a nominal 150 kHz). <b>1. Programming Output Voltage</b> (Selecting R <sub>1</sub> and R <sub>2</sub> , as shown in Figure 1)
Use the following formula to select the appropriate resistor values.	Select $R_1$ to be 1 k $\Omega$ , 1%. Solve for $R_2$ .
$V_{OUT} = V_{REF} \left(1 + \frac{R_2}{R_1}\right)  \text{where}  V_{REF} = 1.23 \text{ V}$	$R_{2} = R_{1} \left( \frac{V_{OUT}}{V_{REF}} - 1 \right) = 1 k \left( \frac{20 V}{1.23 V} - 1 \right)$
Select a value for $R_1$ between 240 $\Omega$ and 1.5 $k\Omega$ . The lower resistor values minimize noise pickup in the sensitive feedback pin. (For the lowest temperature coefficient and the best stability with time, use 1% metal film resistors.)	R <sub>2</sub> =1k (16.26-1)=15.26k, closest 1% value is 15.4kΩ R <sub>2</sub> = 15.4 kΩ.
$R_{2} = R_{1}\left(\frac{V_{OUT}}{V_{REF}} - 1\right)$	
<ul> <li>2. Inductor Selection (L1)</li> <li>A. Calculate the inductor Volt • microsecond constant E•T (V•Us), from the following formula:</li> </ul>	<ul> <li>2. Inductor Selection (L1)</li> <li>A. Calculate the inductor Volt • microsecond constant (E•T),</li> </ul>
$E \bullet T = (V_{IN} - V_{OUT} - V_{SAT}) \bullet \frac{V_{OUT} + V_D}{V_{IN} - V_{SAT} + V_D} \bullet \frac{1000}{150 \text{kHz}} (V \bullet \mu s)$	$E \bullet T = (28 - 20 - 1.16) \bullet \frac{20 + 0.5}{28 - 1.16 + 0.5} \bullet \frac{1000}{150} (V \bullet \mu s)$
where $V_{SAT}$ = internal switch saturation voltage = 1.16V and $V_D$ = diode forward voltage drop = 0.5V	$E \bullet T = (6.84) \bullet \frac{20.5}{27.34} \bullet 6.67 (V \bullet \mu s) = 34.2 (V \bullet \mu s)$
<b>B.</b> Use the E•T value from the previous formula and match it with the E•T number on the vertical axis of the Inductor Value Selection Guide shown in Figure 7.	<b>B.</b> E•T=34.2 (V•Us)
<b>C.</b> on the horizontal axis, select the maximum load current.	<b>C.</b> $I_{LOAD}$ (max) = 3A
<ul> <li>D. Identify the inductance region intersected by the E•T value and the Maximum Load Current value. Each region is identified by an inductance value and an inductor code (LXX).</li> <li>E. Select an appropriate inductor from the four manufacturer's part numbers listed in Figure 8.</li> </ul>	<ul> <li>D. From the inductor value selection guide shown in Figure 7, the inductance region intersected by the 34 (V•Us) horizontal line and the 3A vertical line is 47 UH, and the inductor code is L39.</li> <li>E. From the table in Figure 8, locate line L39, and select an inductor part number from the list of manufacturers part numbers.</li> </ul>
<b>3. Output Capacitor Selection (C<sub>OUT</sub>)</b> <b>A.</b> In the majority of applications, low ESR electrolytic or solid tantalum capacitors between 82 UF and 820 UF provide the best results. This capacitor should be located close to the IC using short capacitor leads and short copper traces. Do not use capacitors larger than 820 UF.	3. Output Capacitor Selection (C <sub>OUT</sub> )
<b>B.</b> To simplify the capacitor selection procedure, refer to the quick design table shown in Figure 3. This table contains different output voltages, and lists various output capacitors that will provide the best design solutions.	<b>B.</b> From the quick design table shown in Figure 3, locate the output voltage column. From that column, locate the output voltage closest to the output voltage in your application. In this example, select the 24V line. Under the output capacitor section, select a capacitor from the list of through hole electrolytic or surface mount tantalum types from four different capacitor manufacturers. It is recommended that both the manufacturers and the manufacturers series that are listed in the table be used. In this example, through hole aluminum electrolytic capacitors from several different manufacturers are available. 220 UF/35V Panasonic HFQ Series 150 UF/35V Nichicon PL Series
<b>C.</b> The capacitor voltage rating should be at least 1.5 times greater than the output voltage, and often much higher voltage ratings are needed to satisfy the low ESR requirements needed for low output ripple voltage.	<b>C.</b> For a 20V output, a capacitor rating of at least 30V or more is needed. In this example, either a 35V or 50V capacitor would work. A 35V rating was chosen, although a 50V rating could also be used if a lower output ripple voltage is needed. Other manufacturers or other types of capacitors may also be used, provided the capacitor specifications



PROCEDURE (Adjustable Output Voltage Version)	EXAMPLE (Adjustable Output Voltage Version)
	(especially the 100 kHz ESR) closely match the types listed in the table. Refer to the capacitor manufacturers data sheet for this information.
<b>4. Feedforward Capacitor (C<sub>FF</sub>)</b> (See Figure 1) For output voltages greater than approximately 10V, an additional capacitor is required. The compensation capacitor is typically between 100 pF and 33 nF, and is wired in parallel with the output voltage setting resistor, R2. It provides additional stability for high output voltages, low input-output voltages, and/or very low ESR output capacitors, such as solid tantalum capacitors. $C_{FF} = \frac{1}{31 \times 10^3 \times R_2}$	<b>4. Feedforward Capacitor (C<sub>FF</sub> )</b> The table shown in Figure 3 contains feed forward capacitor values for various output voltages. In this example, a 560 pF capacitor is needed.
This capacitor type can be ceramic, plastic, silver mica, etc. (" ecause of the unstable characteristics of ceramic capacitors made with Z5U material, they are not recommended.)	

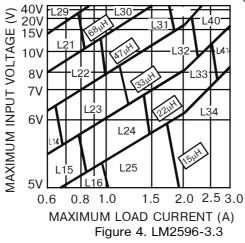
## LM2596 SERIES BUCK REGULATOR DESING PROCEDURE (ADJUSTABLE OUTPUT)

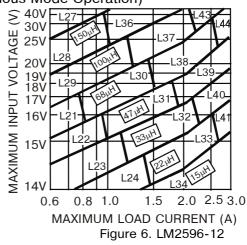
Output	Through	n Hole Output C	apacitor	Surface Mount Output Capacitor			
Output Voltage (V)	Panasonic HFQ Series (μF/V)	Nichicon PL Series (μF/V)	Feedforward capacitor	AVX TPS Series (μF/V)	Sprague 595D Series (µF/V)	Feedforward Capacitor	
2	820/35	820/35	33 nF	330/6.3	470/4	33 nF	
4	560/35	470/35	10 nF	330/6.3	390/6.3	10 nF	
6	470/25	470/25	3.3 nF	220/10	330/10	3.3 nF	
9	330/25	330/25	1.5 nF	100/16	180/16	1.5 nF	
12	330/25	330/25	1 nF	100/16	180/16	1 nF	
15	220/35	220/35	680 pF	68/20	120/20	680 pF	
24	220/35	150/35	560 pF	33/25	33/25	220 pF	
28	100/50	100/50	390 pF	10/35	15/50	220 pF	

Figure 3. Output Capacitor and Feedforward Capacitor Selection Table

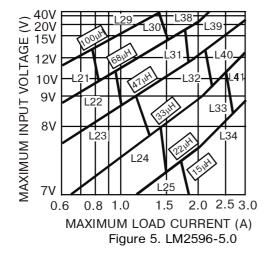
## LM2596 SERIES BUCK REGULATOR DESIGN PROCEDURE

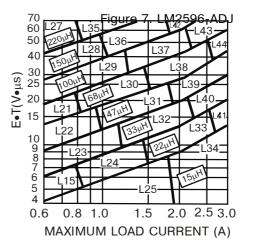
Inductor Value Selection Guides (For Continuous Mode Operation)











## LM2596 SERIES BUCK REGULATOR DESIGN PROCEDURE (Continued)

	LM2596 SERIES BUCK REGULATOR DESIGN PROCEDURE (Continued)								
	Inductance	Cur-			Renco		Pulse Engineering		Coilcraft
	(μH)	rent	Through		Through		Through	Surface	Surface
		(A)	Hole	Mount	Hole	Mount	Hole	Mount	Mount
L15	22	0.99	67148350	67148460	RL-1284-22-43	RL1500-22	PE-53815	PE-53815-S	DO3308-223
L21	68	0.99	67144070	67144450	RL-5471-5	RL1500-68	PE-53821	PE-53821-S	DO3316-683
	47	1.17	67144080	67144460	RL-5471-6	-	PE-53822	PE-53822-S	DO3316-473
L23		1.40	67144090	67144470	RL-5471-7	-	PE-53823	PE-53823-S	DO3316-333
L24	22	1.70	67148370	67148480	RL-1283-22-43	-	PE-53824	PE-53825-S	DO3316-223
L25	15	2.10	67148380	67148490	RL-1283-15-43	-	PE-53825	PE-53824-S	DO3316-153
L26	330	0.80	67144100	67144480	RL-5471-1	-	PE-53826	PE-53826-S	DO5022P-334
L27	220	1.00	67144110	67144490	RL-5471-2	-	PE-53827	PE-53827-S	DO5022P-224
L28	150	1.20	67144120	67144500	RL-5471-3	-	PE-53828	PE-53828-S	DO5022P-154
L29	100	1.47	67144130	67144510	RL-5471-4	-	PE-53829	PE-53829-S	DO5022P-104
L30	68	1.78	67144140	67144520	RL-5471-5	-	PE-53830	PE-53830-S	DO5022P-683
L31	47	2.20	67144150	67144530	RL-5471-6	-	PE-53831	PE-53831-S	DO5022P-473
L32	33	2.50	67144160	67144540	RL-5471-7	-	PE-53932	PE-53932-S	DO5022P-333
L33	22	3.10	67148390	67148500	RL-1283-22-43	-	PE-53933	PE-53933-S	DO5022P-223
L34	15	3.40	67148400	67148790	RL-1283-15-43	-	PE-53934	PE-53934-S	DO5022P-153
L35	220	1.70	67144170	-	RL-5473-1	-	PE-53935	PE-53935-S	-
L36	150	2.10	67144180	-	RL-5473-4	-	PE-54036	PE-54036-S	-
L37	100	2.50	67144190	-	RL-5472-1	-	PE-54037	PE-54037-S	-
L38	68	3.10	67144200	-	RL-5472-2	-	PE-54038	PE-54038-S	-
L39	47	3.50	67144210	-	RL-5472-3	-	PE-54039	PE-54039-S	-
L40	33	3.50	67144220	67148290	RL-5472-4	-	PE-54040	PE-54040-S	-
L41	22	3.50	67144230	67148300	RL-5472-5	-	PE-54041	PE-54041-S	-
L42	150	2.70	67148410	-	RL-5473-4	-	PE-54042	PE-54042-S	-
L43	100	3.40	67144240	-	RL-5473-2	-	PE-54043		-
L44	68	3.40	67144250	-	RL-5473-3	-	PE-54044		-

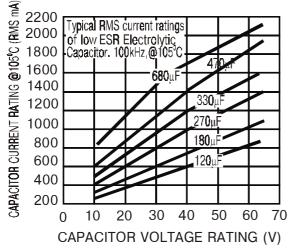
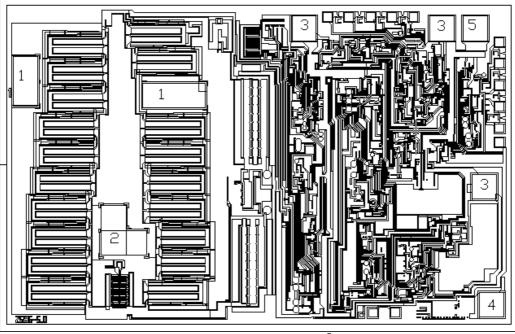


Figure 8. Inductor Manufacturers Part Numbers

Figure 9. RMS Current Ratings for Low ESR Electrolytic Capacitors (typical)



## PAD DIAGRAM



Chip Size 4.2 x 2.7 mm<sup>2</sup>

## **PAD LOCATIONS COORDINATES**

Pad	Pad Name	Pad Size	Coordinates µm		
Ν	Fau Maine	μ <b>m</b>	Х	Y	
1	V <sub>IN</sub>	200 x 400	210	2023	
1	V <sub>IN</sub>	505 x 205	1412	1911	
2	Out	205 x 400	925	720	
3	GND	200 x 200	2461	2454	
3	GND	200 x 200	3578	2454	
3	GND	200 x 200	3921	1174	
4	F"	200 x 200	3980	220	
5	ON/OFF	200 x 200	3848	2454	



MILLIMETERS

MIN MAX

1.702 BSC

MILLIMETERS

MIN MAX

0.660 0.914

1.143 1.397 1.702 BSC

13.691 14.707

1.270 REF

0.000 0.254

0.457 0.660

1.473 1.981 5° REF

2.946 REF

5.080 MIN

6.350 MIN

10.236

9.347 4.572

2.591

9.804

9.042

0.050 REF

0.088

0.018

0.058 58 0.078 5 ° REF

Μ

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U V

0.000 0.010

0.116 REF

0.200 MIN

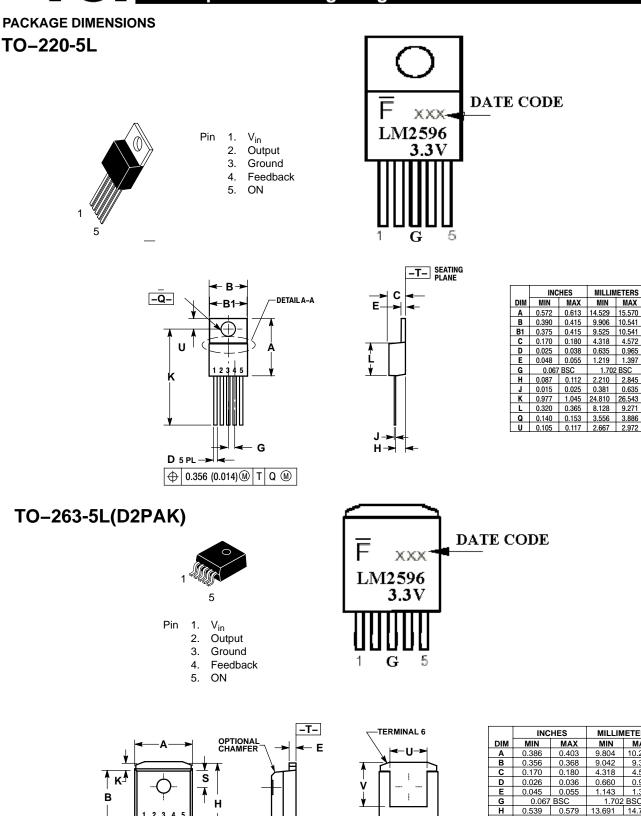
0.250 MIN

0.102

0.026

4.318

2.235



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⊕ 0.010 (0.254) M T

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